



ABSOLUTE MAXIMUM RATINGS (Note 1)				
PARAMETER	SYMBOL	LIMIT	UNIT	
Input Supply Voltage (Note 2)	V _{IN}	-18 ~ +60	V	
Operation Input Supply Voltage	V_{OPR}	26	V	
Power Dissipation ^(Note 3)	P _D	Internally Limited	W	
Operating Junction Temperature Range	T _J	-40 ~ +125	°C	
Storage Temperature Range	T _{STG}	-65 ~ +150	°C	

THERMAL PERFORMANCE				
PARAMETER	SYMBOL	LIMIT	UNIT	
Junction to Case Thermal Resistance	R _{eJC}	20	°C/W	

Notes: $R_{\Theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistances. The case thermal reference is defined at the solder mounting surface of the drain pins. $R_{\Theta JA}$ is guaranteed by design while $R_{\Theta CA}$ is determined by the user's board design. $R_{\Theta JA}$ shown below for single device operation on FR-4 PCB in still air.

ELECTRICAL SPECIFICATIONS (V _{IN} =V _{OUT} +1V, I _L =5mA, C _O =10μF, T _A =25°C, unless otherwise noted)					
PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
	T 25°0	3.23	3.3	3.36	
Output Voltage	T _A =25°C	4.9	5	5.1	\ \ -
	T 05 05°0	3.17	3.3	3.43	
	T _A =25~85°C	4.8	5	5.2	
Output Voltage Temperature Coefficient			50	150	ppm/°C
Line Regulation	$Vo+1V \le V_{IN} \le 26V$		0.05	0.5	%
Load Regulation	$5mA \le I_L \le 500mA$		0.2	1.0	%
Dropout Voltage ^(Note 4)	I _L =100mA		100	200	mV
	I _L =300mA		300	400	
	I _L =500mA		500	600	
	I _L =100μA		200	300	μA
Quiescent Current (Note 5)	I _L =300mA		12	20	mA
	I _L =500mA		25	50	
Short Circuit Current (Note 6)	V _{OUT} =0		0.9	1.3	А
Output Noise, 10Hz to 100KHz, I _L =10mA	C _L =2.2µF		500		μVrms
	C _L =3.3µF		350		
	C _L =33µF		120		
Ripple Rejection	Ratio	60			dB





ELECTRICAL SPECIFICATIONS $(V_{IN}=V_{OUT}+1V,\ I_L=5mA,\ C_O=10\mu F,\ T_A=25^{\circ}C,\ unless\ otherwise\ noted)$					
PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
Shutdown Input					
Input Logic Voltage	Low (Regulator ON)		1.3	0.7	V
	High (Regulator OFF)	2.0			
Shutdown Pin Input Current	V _{INHIBIT} = 2.4V		30	50	
	V _{INHIBIT} = 26V		450	600	Δ
Regulator Output Current in Shutdown	$V_{\text{INHIBIT}} \le 2V, V_{\text{IN}} \le 26V$ $V_{\text{OUT}} = 0V$			200	μΑ

Note:

- 1. Absolute Maximum Rating is limits beyond which damage to the device may occur. For guaranteed specifications and test conditions see the electrical characteristics.
- 2. Maximum positive supply voltage of 60V must be limited duration (<100ms) and duty cycle (<1%).
- 3. The maximum allowable power dissipation is a function of the maximum junction temperature, T_J, the junction to ambient thermal resistance, R_{ΘJA}, and the ambient temperature, Ta. Exceeding the maximum allowable power dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown. The effective value of R_{ΘJA} can be reduced by using a heatsink.
- **4.** Dropout voltage is defined as the input to output differential at which the output voltage drops 2% below its nominal value measured at 1V differential.
- **5.** Ground pin current is the regulator quiescent current. The total current drawn from the source is the sum of the ground pin current and output load current.
- **6.** Output current will decrease with increasing temperature, but it will be not dropped below 500mA at the maximum specified temperature.



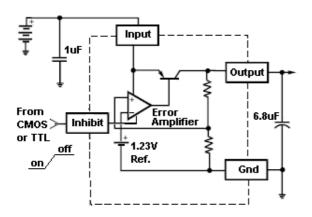
ORDERING INFORMATION

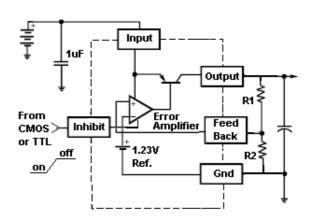
VOLTAGE	PART NO.	PACKAGE	PACKING
5.0V	TS2938CS50 RLG	SOP-8	2,500pcs / 13" Reel
3.3V	TS2938CS33 RLG	SOP-8	2,500pcs / 13" Reel

Note:

- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC.
- 2. Halogen-free according to IEC 61249-2-21 definition.

BLOCK DIAGRAM





APPLICATION INFORMATION

The TS2938 series is a high performance with low dropout voltage regulator suitable for moderate to high current and voltage regulator application. Its 500mV (typ.) dropout voltage at full load and over temperature makes it especially valuable in battery power systems and as high efficiency noise filters in post regulator applications. Unlike normal NPN transistor design, where the base to emitter voltage drop and collector to emitter saturation voltage limit the minimum dropout voltage, dropout performance of the PNP output of these devices is limited only by low V_{CE} saturation voltage.

The TS2938 series is fully protected from damage due to fault conditions. Linear current limiting is provided. Output current during overload conditions is constant. Thermal shutdown the device when the die temperature exceeds the maximum safe operating temperature. Transient protection allows device survival even when the input voltage spikes above and below nominal. The output structure of these regulators allows voltages in excess of the desired output voltage to be applied without reverse current flow.

Output Capacitor

The TS2938 series requires an output capacitor to maintain stability and improve transient response. Proper capacitor selection is important to ensure proper operation. The output capacitor selection is dependent upon the ESR of the output capacitor the maintain stability. When the output capacitor is 6.8µF or greater, the output capacitor should have an ESR less than 20hm. This will improve transient response as well as promoted stability. Ultra low ESR capacitors (<100mohm), such as ceramic chip capacitors may promote instability. These very low ESR levels may cause an oscillation and/or under damped transient response. A low ESR solid tantalum capacitor works extremely well and provide good transient response and stability over temperature. Aluminum electrolytic can also be used, as long as the ESR of the capacitor is <20hm. The value of the output capacitor can be increased without limit. Higher capacitance values help to improved transient response and ripple rejection and reduce output noise.

Version: G15



APPLICATION INFORMATION (CONTINUED)

Minimum Load Current

The TS2938 series is specified between finite loads. If the output current is too small leakage currents dominate and the output voltage rises. A 5mA minimum load current is necessary for proper regulation.

Input Capacitor

An input capacitor of $1\mu F$ or greater is recommended when the device is more that 4 inches away from the bulk AC supply capacitance or when the supply is a battery. Small and surface mount ceramic chip capacitors can be used for bypassing. Larger values will help to improve ripple rejection by bypassing the input to the regulator, further improving the integrity of the output voltage.

Thermal Characteristics

A heatsink may be required depending on the maximum power dissipation and maximum ambient temperature of the application. Under all possible operating conditions, the junction temperature must be within the range specified under absolute maximum ratings. To determine if the heatsink is required, the power dissipated by the regulator, P_D must be calculated.

The below formula shows the voltages and currents for calculating the P_D in the regulator:

```
I_{IN} = I_L / I_G
P_D = (V_{IN} - V_{OUT}) * I_L + (V_{IN}) * I_G
Ex. P_D = (3.3V - 2.5V) * 0.5A + 3.3V * 11mA
= 400mW + 36mW
= 436mW
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The next parameter which must be calculated the maximum allowable temperature rise.

 $T_R(max)$ is calculated by the using to formula:

```
T_R(max) = T_J(max) - T_A(max)
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Where: $T_J(max)$ is the maximum allowable junction temperature, which is $125^{\circ}C$ for commercial grade parts. $T_A(max)$ is the maximum ambient temperature which will be encountered in the application.

Using the calculated values for $T_A(max)$ and P_D , the maximum allowable value for the junction to ambient thermal resistance, θ_{JA} , can now be found:

$$\theta_{JA} = T_R(max) / P_D$$

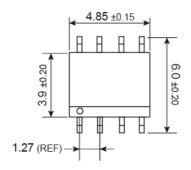
Inhibit Input

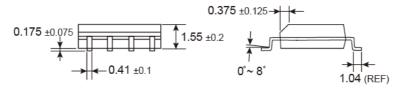
TS2938 feature an active-low (Inhibit) input that allows ON/OFF control of the regulator. The Inhibit input has TTL/CMOS compatible thresholds for simple interfacing with logic interfacing. Inhibit should be directly tied to Ground or keep open (not connected).



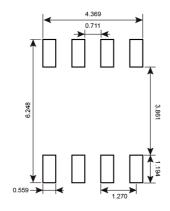
PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

SOP-8





SUGGESTED PAD LAYOUT (Unit: Millimeters)



MARKING DIAGRAM



XX = Voltage Code (**50**=5.0V, **33**=3.3V)

Y = Year Code

M = Month Code for Halogen Free Product

O =Jan P =Feb Q =Mar R =Apr S =May T =Jun U =Jul V =Aug

W =Sep X =Oct Y =Nov Z =Dec

L = Lot Code



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